

PRELIMINARY

CY7C1019

128K x 8 Static RAM

Features

- High speed
- t_{AA} = 10 nsCMOS for optimum speed/power
- Center power/ground pinout
- Automatic power-down when deselected
- Easy memory expansion with CE and OE options

Functional Description

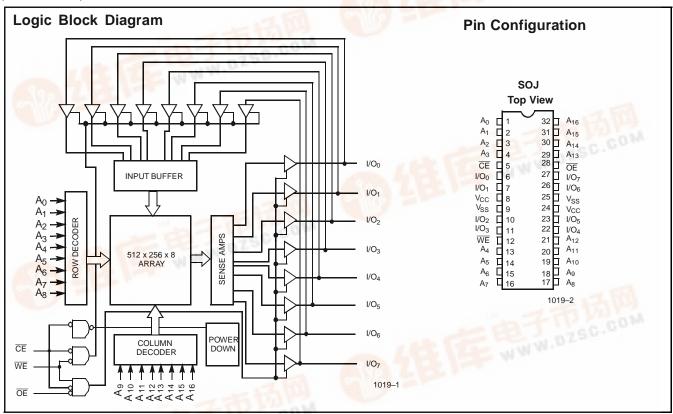
The CY7C1019 is a high-performance CMOS static RAM organized as 131,072 words by 8 bits. Easy memory expansion is provided by an active LOW chip enable $(\overline{\text{CE}})$, an active LOW output enable $(\overline{\text{OE}})$, and three-state drivers. This device has an automatic power-down feature that significantly reduces power consumption when deselected.

Writing to the device is accomplished by taking chip enable (\overline{CE}) and write enable (\overline{WE}) inputs LOW. Data on the eight I/O pins $(I/O_0$ through I/O_7) is then written into the location specified on the address pins $(A_0$ through A_{16}).

Reading from the device is accomplished by taking chip enable (CE) and output enable (OE) LOW while forcing write enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins (I/O $_0$ through I/O $_7$) are placed in a high-impedance state when the device is deselected ($\overline{\text{CE}}$ HIGH), the outputs are disabled ($\overline{\text{OE}}$ HIGH), or during a write operation ($\overline{\text{CE}}$ LOW, and $\overline{\text{WE}}$ LOW).

The CY7C1019 is available in standard 400-mil-wide SOJs.



Selection Guide

df.dzsc.com

	7C1019-10	7C1019-12	7C1019-15
	10	12	15
	240	220	200
L	210	190	175
	10	10	10
L	1	1	1
	L	10 240 L 210 10	10 12 240 220 L 210 190 10 10



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Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.) Storage Temperature-65°C to +150°C Ambient Temperature with Power Applied55°C to +125°C Supply Voltage on V_{CC} to Relative $\mbox{GND}^{[1]}\,....\,-0.5\mbox{V}$ to +7.0V DC Voltage Applied to Outputs in High Z State $^{[1]}$ -0.5V to V CC + 0.5V DC Input Voltage^[1].....-0.5V to V_{CC} + 0.5V

Current into Outputs (LOW)	20 mA
Static Discharge Voltage(per MIL-STD-883, Method 3015)	>2001V
Latch-Up Current	>200 mA

Operating Range

Range	Ambient Temperature ^[2]	v _{cc}
Commercial	0°C to +70°C	5V ± 10%

Electrical Characteristics Over the Operating Range

				7C10	019-10	7C10	019-12	7C10)19-15	
Parameter	Description			Min.	Max.	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min., I_{OH} = -4.0$	mΑ	2.4		2.4		2.4		V
V_{OL}	Output LOW Voltage	V _{CC} = Min., I _{OL} = 8.0 m	A		0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage	00 102		2.2	V _{CC} + 0.3	2.2	V _{CC} + 0.3	2.2	V _{CC} + 0.3	V
V_{IL}	Input LOW Voltage ^[1]			-0.3	0.8	-0.3	0.8	-0.3	0.8	V
I _{IX}	Input Load Current	$GND \le V_I \le V_{CC}$		-1	+1	-1	+1	-1	+1	μΑ
I _{OZ}	Output Leakage Current	$\begin{aligned} & \text{GND} \leq \text{V}_{\text{I}} \leq \text{V}_{\text{CC}}, \\ & \text{Output Disabled} \end{aligned}$		-5	+5	-5	+5	-5	+5	μА
I _{CC}	V _{CC} Operating	V _{CC} = Max.,			240		220		200	mA
	Supply Current	$I_{OUT} = 0 \text{ mA},$ $f = f_{MAX} = 1/t_{RC}$	L		210		190		175	
I _{SB1}	Automatic CE	Max. V _{CC} , CE ≥ V _{IH}			40		40		40	mA
	Power-Down Current —TTL Inputs	$V_{IN} \ge V_{IH}$ or $V_{IN} \le V_{IL}$, $f = f_{MAX}$	L		20		20		20	
I _{SB2}	Automatic CE	Max. V _{CC} ,			10		10		10	mA
	Power-Down Current —CMOS Inputs	$\overline{CE} \ge V_{CC} - 0.3V,$ $V_{IN} \ge V_{CC} - 0.3V,$ or $V_{IN} \le 0.3V,$ f=0	L		1		1		1	1

Shaded areas contain advance information.

Capacitance^[3]

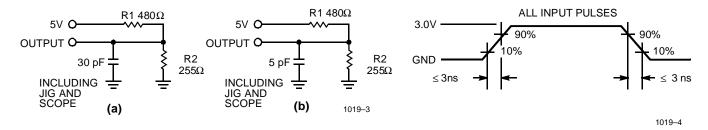
Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C$, $f = 1$ MHz,	6	pF
C _{OUT}	Output Capacitance	$V_{CC} = 5.0V$	8	pF

Notes:

- 1. V_{IL} (min.) = -2.0V for pulse durations of less than 20 ns.
- T_A is the "instant on" case temperature.
 Tested initially and after any design or process changes that may affect these parameters.



AC Test Loads and Waveforms



Equivalent to: THÉVENIN EQUIVALENT

Switching Characteristics^[4] Over the Operating Range

		7C10	7C1019-10 7C1019-12		7C10	19-15		
Parameter	Parameter Description Min. N		Max.	Min.	Max.	Min.	Max.	Unit
READ CYC	LE	1	•			•	•	1
t _{RC}	Read Cycle Time	10		12		15		ns
t _{AA}	Address to Data Valid		10		12		15	ns
t _{OHA}	Data Hold from Address Change	3		3		3		ns
t _{ACE}	CE LOW to Data Valid		10		12		15	ns
t _{DOE}	OE LOW to Data Valid		5		6		7	ns
t _{LZOE}	OE LOW to Low Z	0		0		0		ns
t _{HZOE}	OE HIGH to High Z ^[5, 6]		5		6		7	ns
t _{LZCE}	CE LOW to Low Z ^[6]	3		3		3		ns
t _{HZCE}	CE HIGH to High Z ^[5, 6]		5		6		7	ns
t _{PU}	CE LOW to Power-Up	0		0		0		ns
t _{PD}	CE HIGH to Power-Down		10		12		15	ns
WRITE CYC	CLE ^[7,8]							
t _{WC}	Write Cycle Time	10		12		15		ns
t _{SCE}	CE LOW to Write End	8		9		10		ns
t _{AW}	Address Set-Up to Write End	7		8		10		ns
t _{HA}	Address Hold from Write End	0		0		0		ns
t _{SA}	Address Set-Up to Write Start	0		0		0		ns
t _{PWE}	WE Pulse Width	7		8		10		ns
t _{SD}	Data Set-Up to Write End	5		6		8		ns
t _{HD}	Data Hold from Write End	0		0		0		ns
t _{LZWE}	WE HIGH to Low Z ^[6]	3		3		3		ns
t _{HZWE}	WE LOW to High Z ^[5, 6]		5		6		7	ns

Shaded areas contain advance information.

Note:

- Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V, and output loading of the specified I_{OL}/I_{OH} and 30-pF load capacitance.
- THZOE, HZCE, and tHZWE are specified with a load capacitance of 5 pF as in part (b) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage.
- At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE}, t_{HZCE} is less than t_{LZWE} is less than t_{LZWE} for any given device.

 The internal write time of the memory is defined by the overlap of CE LOW and WE LOW. CE and WE must be LOW to initiate a write, and the transition of any of these signals can terminate the write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the write.

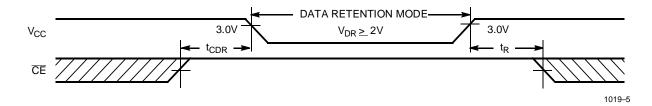
 The minimum write cycle time for Write Cycle no. 3 (WE controlled, OE LOW) is the sum of t_{HZWE} and t_{SD}.



Data Retention Characteristics Over the Operating Range (L Version Only)

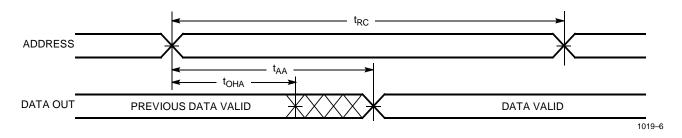
Parameter	Description	Conditions	Min.	Max	Unit
V _{DR}	V _{CC} for Data Retention	No input may exceed V _{CC} + 0.5V	2.0		V
I _{CCDR}	Data Retention Current	$\frac{V_{CC}}{CE_1} = V_{DR} = 3.0V,$ $\frac{CE_1}{CE_1} \ge V_{CC} - 0.3V,$		300	μΑ
t _{CDR} ^[3]	Chip Deselect to Data Retention Time	$V_{\text{IN}} \ge V_{\text{CC}} - 0.3 \text{V or } V_{\text{IN}} \le 0.3 \text{V}$	0		ns
t _R	Operation Recovery Time		t _{RC}		ns

Data Retention Waveform

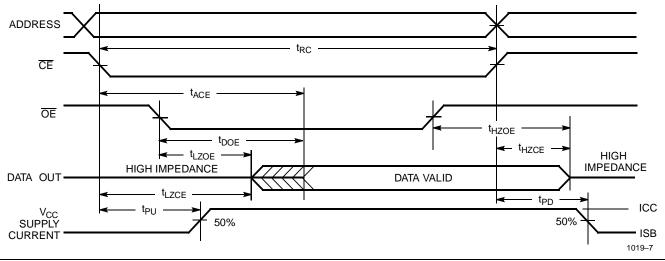


Switching Waveforms

Read Cycle No. $\mathbf{1}^{[9, 10]}$



Read Cycle No. 2 (OE Controlled)[10, 11]



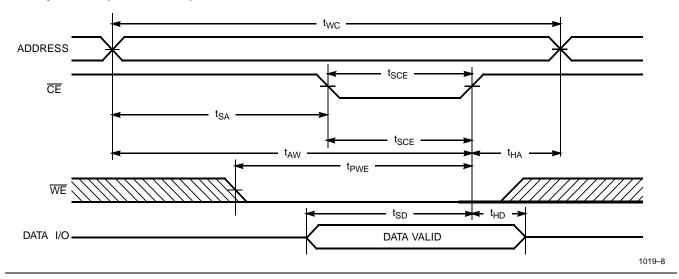
Notes:

- Device is continuously selected. \overline{OE}, \overline{CE} = V_{IL}.
 WE is HIGH for read cycle.
 Address valid prior to or coincident with \overline{CE} transition LOW.

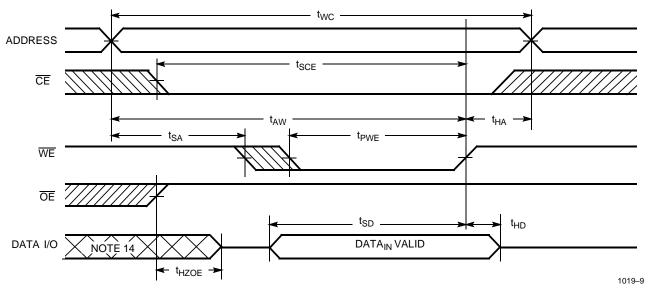


Switching Waveforms (continued)

Write Cycle No. 1 (CE Controlled)[12, 13]



Write Cycle No. 2 (WE Controlled, OE HIGH During Write)[12, 13]



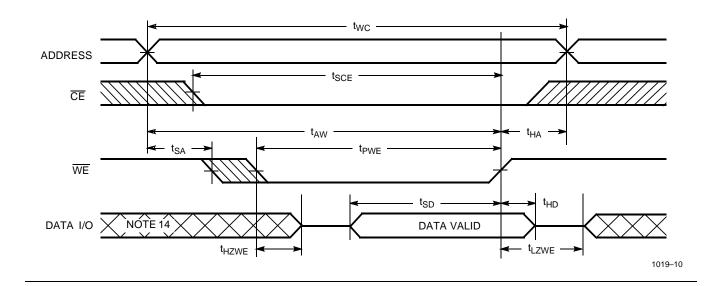
Notes:

- 12. Data I/O is high impedance if OE = V_{IH}.
 13. If CE goes HIGH simultaneously with WE going HIGH, the output remains in a high-impedance state.
 14. During this period the I/Os are in the output state and input signals should not be applied.



Switching Waveforms (continued)

Write Cycle No. 3 ($\overline{\text{WE}}$ Controlled, $\overline{\text{OE}}$ LOW)[13]



Truth Table

CE	OE	WE	I/O ₀ -I/O ₇	Mode	Power
Н	Х	Х	High Z	Power-Down	Standby (I _{SB})
Х	Х	Х	High Z	Power-Down	Standby (I _{SB})
L	L	Н	Data Out	Read	Active (I _{CC})
L	Х	L	Data In	Write	Active (I _{CC})
L	Н	Н	High Z	Selected, Outputs Disabled	Active (I _{CC})

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Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range
10	CY7C1019-10VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
	CY7C1019L-10VC	V33	32-Lead 400-Mil Molded SOJ	
12	CY7C1019-12VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
	CY7C1019L-12VC	V33	32-Lead 400-Mil Molded SOJ	
15	CY7C1019-15VC	V33	32-Lead 400-Mil Molded SOJ	Commercial
	CY7C1019L-15VC	V33	32-Lead 400-Mil Molded SOJ	

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Package Diagram

32-Lead (400-Mil) Molded SOJ V33

